## onsemi

## MOSFET – Power, Dual, N-Channel

### 60 V, 11.9 mΩ, 49 A

## NTMFD5C672NL

#### Features

- Small Footprint (5x6 mm) for Compact Design
- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V <sub>DSS</sub>	60	V
Gate-to-Source Voltage			V <sub>GS</sub>	±20	V
Continuous Drain	Steady	$T_{C} = 25^{\circ}C$	I <sub>D</sub>	49	А
Current $R_{\theta JC}$ (Notes 1, 2, 3)		$T_{C} = 100^{\circ}C$		32	
Power Dissipation	State	T <sub>C</sub> = 25°C	PD	45	W
$R_{\theta JC}$ (Notes 1, 2)		$T_{C} = 100^{\circ}C$		22	
Continuous Drain	Steady	$T_A = 25^{\circ}C$	I <sub>D</sub>	12	А
Current R <sub>θJA</sub> (Notes 1, 2, 3)		T <sub>A</sub> = 100°C		8.0	
Power Dissipation	State	T <sub>A</sub> = 25°C	PD	3.1	W
$R_{\theta JA}$ (Notes 1 & 2)		T <sub>A</sub> = 100°C		1.5	
Pulsed Drain Current	T <sub>A</sub> = 25	°C, t <sub>p</sub> = 10 μs	I <sub>DM</sub>	146	А
Operating Junction and Storage Temperature			T <sub>J</sub> , T <sub>stg</sub>	–55 to + 175	°C
Source Current (Body Diode)			۱ <sub>S</sub>	49	А
Single Pulse Drain-to-Source Avalanche Energy ( $I_{L(pk)} = 2 A$ )			E <sub>AS</sub>	66	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	2.55	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	49.8	

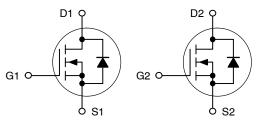
1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

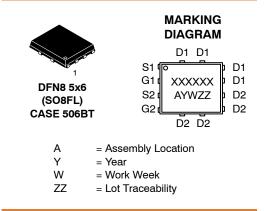
2. Surface-mounted on FR4 board using a 650 mm<sup>2</sup>, 2 oz. Cu pad.

 Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
60 V	11.9 m $\Omega$ @ 10 V	10.4
	16.8 mΩ @ 4.5 V	49 A

**Dual N-Channel** 





#### ORDERING INFORMATION

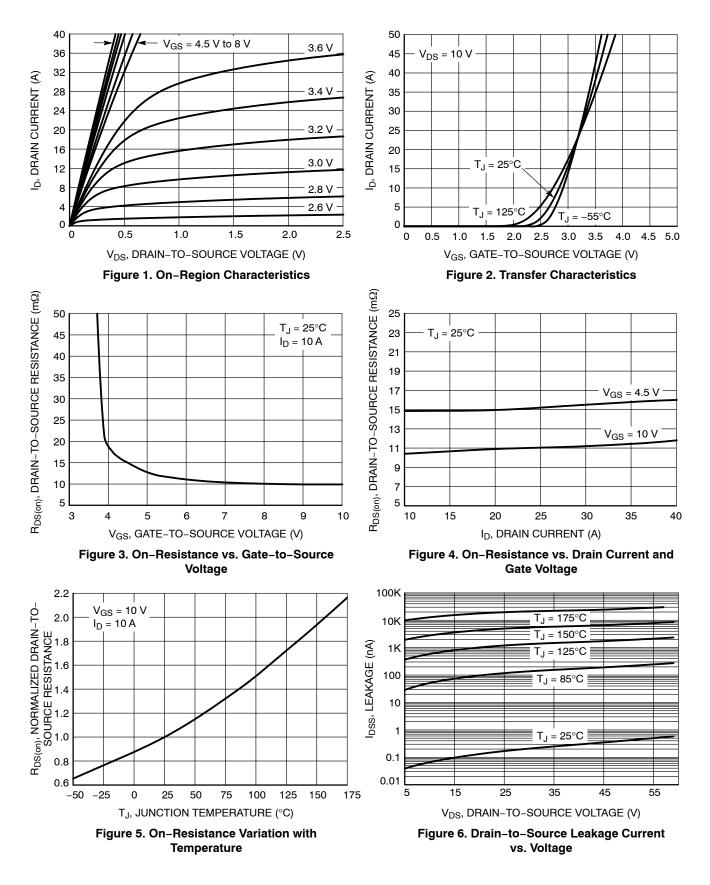
See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise specified)

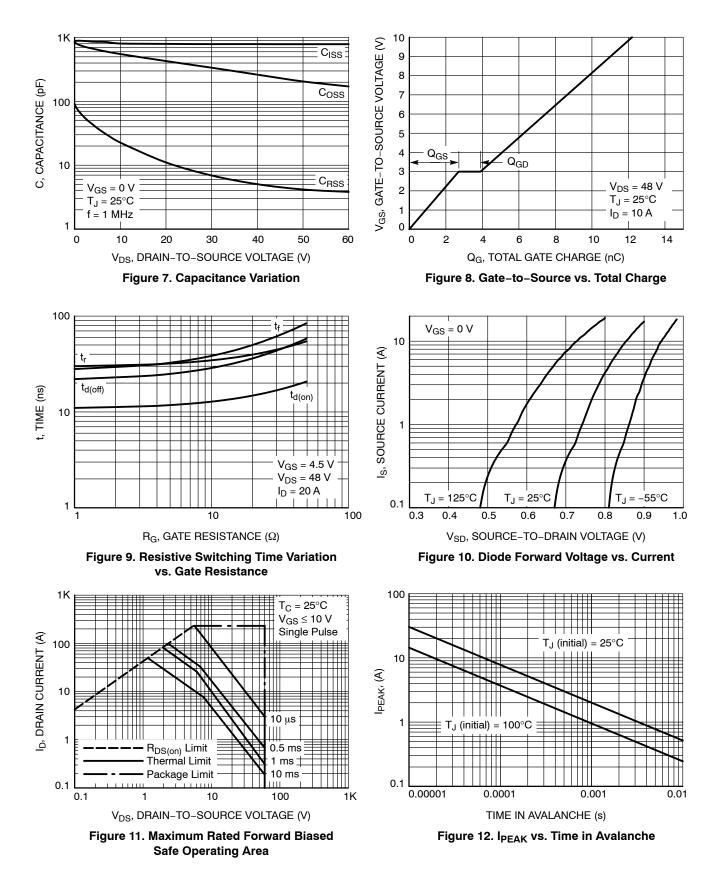
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS				1	1		1
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> / T <sub>J</sub>				27		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS} = 0 V,$	T <sub>J</sub> = 25 °C			10	μΑ
		$V_{DS} = 60 V$	T <sub>J</sub> = 125°C			100	
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = 20 V				100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS}$ = $V_{DS}$ , $I_D$ = 30 $\mu$ A		1.2		2.2	V
Negative Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>				-11.4		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 10 A		9.8	11.9	mΩ
		V <sub>GS</sub> = 4.5 V	I <sub>D</sub> = 10 A		13.4	16.8	
Forward Transconductance	9 <sub>FS</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 10 A			27.5		S
CHARGES, CAPACITANCES & GATE RESIS	TANCE						
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> = 0 V, f = 1 MHz, V <sub>DS</sub> = 25 V			793		pF
Output Capacitance	C <sub>OSS</sub>				383		
Reverse Transfer Capacitance	C <sub>RSS</sub>				9.0		
Total Gate Charge	Q <sub>G(TOT)</sub>	$V_{GS}$ = 4.5 V, $V_{DS}$ = 48 V; $I_{D}$ = 10 A			5.7		
Total Gate Charge	Q <sub>G(TOT)</sub>	$V_{GS}$ = 10 V, $V_{DS}$ = 48 V; $I_{D}$ = 10 A			12.3		
Threshold Gate Charge	Q <sub>G(TH)</sub>	V <sub>DS</sub> = 48 V; I <sub>D</sub> = 10 A			1.5		nC
Gate-to-Source Charge	Q <sub>GS</sub>				2.7		
Gate-to-Drain Charge	Q <sub>GD</sub>				1.2		
Plateau Voltage	V <sub>GP</sub>				2.8		V
SWITCHING CHARACTERISTICS (Note 5)							
Turn-On Delay Time	t <sub>d(ON)</sub>	$V_{GS}$ = 4.5 V, $V_{DS}$ = 48 V, I <sub>D</sub> = 10 A, R <sub>G</sub> = 1.0 Ω			11		
Rise Time	t <sub>r</sub>				30		ns
Turn-Off Delay Time	t <sub>d(OFF)</sub>				22		
Fall Time	t <sub>f</sub>				28		
DRAIN-SOURCE DIODE CHARACTERISTIC	s						
Forward Diode Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 10 A	$T_J = 25^{\circ}C$		0.9	1.2	
-			T <sub>J</sub> = 125°C		0.8		V
Reverse Recovery Time	t <sub>RR</sub>	V <sub>GS</sub> = 0 V, dI <sub>S</sub> /dt = 20 A/μs, I <sub>S</sub> = 10 A			26		
Charge Time	t <sub>a</sub>				12.3		ns
Discharge Time	t <sub>b</sub>				13.5		
Reverse Recovery Charge	Q <sub>RR</sub>				13		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width  $\leq 300 \ \mu$ s, duty cycle  $\leq 2\%$ . 5. Switching characteristics are independent of operating junction temperatures.

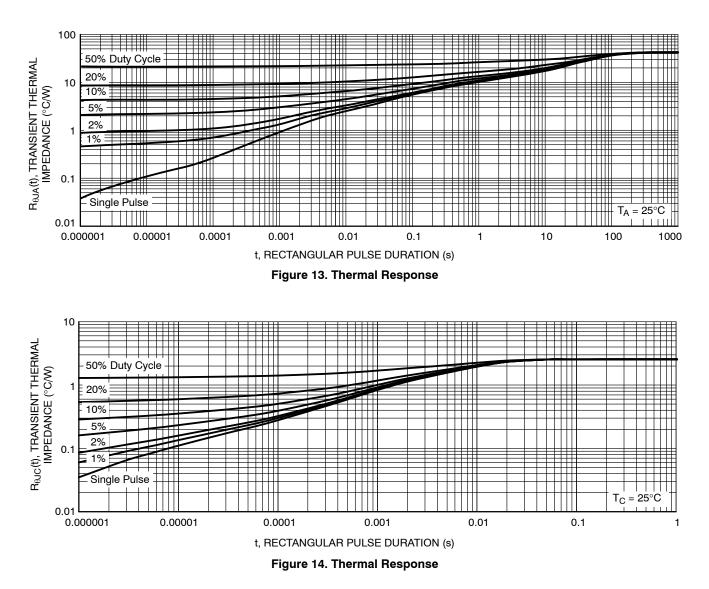
#### **TYPICAL CHARACTERISTICS**



#### **TYPICAL CHARACTERISTICS**



#### **TYPICAL CHARACTERISTICS**



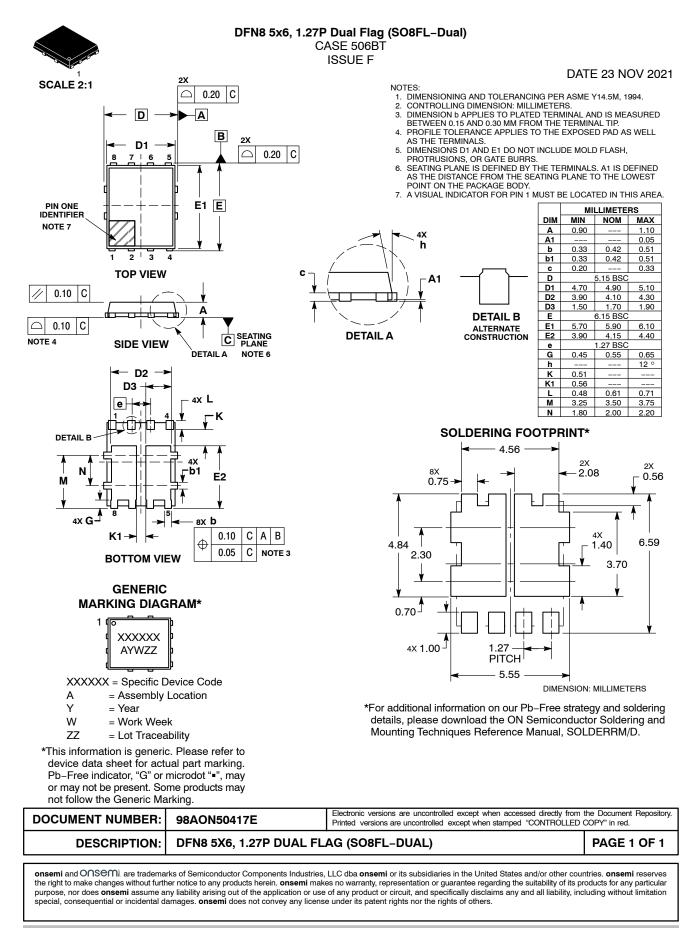
#### **DEVICE ORDERING INFORMATION**

Device	Marking	Package	Shipping <sup>†</sup>
NTMFD5C672NLT1G	5C672L	DFN8 (Pb–Free)	1500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

# ONSEMI



onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent\_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

#### ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>

### **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for ON Semiconductor manufacturer:

Other Similar products are found below :

BD442STU MC74LVX4245DWG MC78M05ACTG MC74LCX16244DTG KA7912ATU FQPF85N06 FQP4N80 MC78M15ACTG NLVVHC1G66DTT1G 2SA2012-TD-E MC74HC11ADTG FMBA14 NCP2823BFCT1G M74HCT4852ADTR2G MC34151P MC7818BTG MC78L08ACDG FDBL0150N80 FEBFL7733A\_L53U021A MOC3042SM FPF2701MX FQD5N15TM FXLA104UM12X GF1B MUR3060WTG BS170\_D74Z NCP1117DTAG NCV303LSN45T1G NCV551SN32T1G NDF04N60ZH NGTB10N60FG NL17SZ125DTT1G NLSX5014DR2G 1N5226B 1N5339B NSP8818MUTAG NTMFS6B05NT1G 1SMB5926BT3G 2SC3648T-TD-E ESD11N5.0ST5G FAN53600AUC33X FCP20N60 FDLL400 FDPC8016S FGH20N60SFDTU FGH40N60SFDTU SURA8220T3G FPF2124 FQD10N20CTM 2N5657G